2-input NOR gate Rev. 06 — 30 May 2007

**Product data sheet** 

### 1. General description

74AHC1G02 and 74AHCT1G02 are high-speed Si-gate CMOS devices. They provide a 2-input NOR function.

The AHC device has CMOS input switching levels and supply voltage range 2 V to 5.5 V.

The AHCT device has TTL input switching levels and supply voltage range 4.5 V to 5.5 V.

### 2. Features

- Symmetrical output impedance
- High noise immunity
- Low power dissipation
- Balanced propagation delays
- SOT353-1 and SOT753 package options
- ESD protection:
  - HBM JESD22-A114E: exceeds 2000 V
  - MM JESD22-A115-A: exceeds 200 V
  - CDM JESD22-C101C: exceeds 1000 V
- Specified from –40 °C to +125 °C

### 3. Ordering information

#### Table 1. Ordering information

| Type number                 | Package           |        |   |          |  |  |  |  |  |
|-----------------------------|-------------------|--------|---|----------|--|--|--|--|--|
|                             | Temperature range | Name   | Description   | Version  |  |  |  |  |  |
| 74AHC1G02GW<br>74AHCT1G02GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package;<br>5 leads; body width 1.25 mm | SOT353-1 |  |  |  |  |  |
| 74AHC1G02GV                 | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads                                  | SOT753   |  |  |  |  |  |
| 74AHCT1G02GV                |                   |        |   |          |  |  |  |  |  |

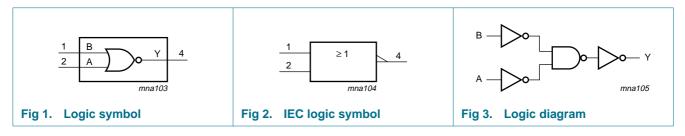


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## 4. Marking

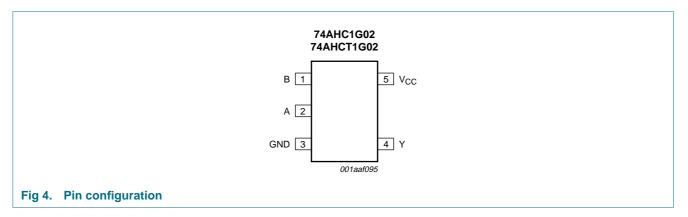
| Table 2.   Marking codes |         |
|--------------------------|---------|
| Type number              | Marking |
| 74AHC1G02GW              | AB      |
| 74AHC1G02GV              | A02     |
| 74AHCT1G02GW             | СВ      |
| 74AHCT1G02GV             | C02     |

## 5. Functional diagram



## 6. Pinning information

## 6.1 Pinning



## 6.2 Pin description

| Table 3.        | Pin description |                |
|-----------------|-----------------|----------------|
| Symbol          | Pin             | Description    |
| В               | 1               | data input B   |
| А               | 2               | data input A   |
| GND             | 3               | ground (0 V)   |
| Y               | 4               | data output Y  |
| V <sub>CC</sub> | 5               | supply voltage |

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## 7. Functional description

#### Table 4.Function table

*H* = *HIGH* voltage level; *L* = *LOW* voltage level

| Inputs |   | Output |
|--------|---|--------|
| Α      | В | Y      |
| L      | L | Н      |
| L      | Н | L      |
| Н      | L | L      |
| Н      | Н | L      |

## 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions  | Min          | Max  | Unit |
|------------------|-------------------------|---|--------------|------|------|
| V <sub>CC</sub>  | supply voltage          |   | -0.5         | +7.0 | V    |
| VI               | input voltage           |   | -0.5         | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V   | -20          | -    | mA   |
| I <sub>OK</sub>  | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V                    | <u>[1]</u> _ | ±20  | mA   |
| lo               | output current          | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | -            | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |   | -            | 75   | mA   |
| I <sub>GND</sub> | ground current          |   | -75          | -    | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65          | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$                               | [2] _        | 250  | mW   |
|                  |                         |   |              |      |      |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For both TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

## 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol                | Parameter             | Conditions                   | 74  | 74AHC1G02 |                 |     | 74AHCT1G02 |                 |      |
|-----------------------|-----------------------|------------------------------|-----|-----------|-----------------|-----|------------|-----------------|------|
|                       |                       |                              | Min | Тур       | Max             | Min | Тур        | Мах             |      |
| V <sub>CC</sub>       | supply voltage        |                              | 2.0 | 5.0       | 5.5             | 4.5 | 5.0        | 5.5             | V    |
| VI                    | input voltage         |                              | 0   | -         | 5.5             | 0   | -          | 5.5             | V    |
| Vo                    | output voltage        |                              | 0   | -         | V <sub>CC</sub> | 0   | -          | V <sub>CC</sub> | V    |
| T <sub>amb</sub>      | ambient temperature   |                              | -40 | +25       | +125            | -40 | +25        | +125            | °C   |
| $\Delta t / \Delta V$ | input transition rise | $V_{CC}$ = 3.3 V $\pm$ 0.3 V | -   | -         | 100             | -   | -          | -               | ns/V |
|                       | and fall rate         | $V_{CC}=5.0~V\pm0.5~V$       | -   | -         | 20              | -   | -          | 20              | ns/V |

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## **10. Static characteristics**

### Table 7.Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                   | Conditions  |      | 25 °C |      | _40 °C | to +85 °C | <b>−40</b> °C | to +125 °C | Unit |
|-----------------|-----------------------------|---|------|-------|------|--------|-----------|---------------|------------|------|
|                 |                             |   | Min  | Тур   | Max  | Min    | Max       | Min           | Max        |      |
| For type        | 74AHC1G02                   |   |      |       |      |        |           |               |            |      |
| VIH             | HIGH-level                  | V <sub>CC</sub> = 2.0 V   | 1.5  | -     | -    | 1.5    | -         | 1.5           | -          | V    |
|                 | input voltage               | V <sub>CC</sub> = 3.0 V   | 2.1  | -     | -    | 2.1    | -         | 2.1           | -          | V    |
|                 |                             | V <sub>CC</sub> = 5.5 V   | 3.85 | -     | -    | 3.85   | -         | 3.85          | -          | V    |
| V <sub>IL</sub> | LOW-level                   | V <sub>CC</sub> = 2.0 V   | -    | -     | 0.5  | -      | 0.5       | -             | 0.5        | V    |
|                 | input voltage               | V <sub>CC</sub> = 3.0 V   | -    | -     | 0.9  | -      | 0.9       | -             | 0.9        | V    |
|                 |                             | V <sub>CC</sub> = 5.5 V   | -    | -     | 1.65 | -      | 1.65      | -             | 1.65       | V    |
| V <sub>OH</sub> | HIGH-level                  | $V_I = V_{IH} \text{ or } V_{IL}$                                 |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_{O}$ = -50 $\mu$ A; $V_{CC}$ = 2.0 V                           | 1.9  | 2.0   | -    | 1.9    | -         | 1.9           | -          | V    |
|                 |                             | $I_{O} = -50 \ \mu\text{A}; \ V_{CC} = 3.0 \ \text{V}$            | 2.9  | 3.0   | -    | 2.9    | -         | 2.9           | -          | V    |
|                 |                             | $I_O = -50 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$              | 4.4  | 4.5   | -    | 4.4    | -         | 4.4           | -          | V    |
|                 |                             | $I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$                 | 2.58 | -     | -    | 2.48   | -         | 2.40          | -          | V    |
|                 |                             | $I_{O}$ = -8.0 mA; $V_{CC}$ = 4.5 V                               | 3.94 | -     | -    | 3.8    | -         | 3.70          | -          | V    |
| V <sub>OL</sub> | LOW-level                   | $V_I = V_{IH} \text{ or } V_{IL}$                                 |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_{O} = 50 \ \mu A; \ V_{CC} = 2.0 \ V$                          | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_{O} = 50 \ \mu A; \ V_{CC} = 3.0 \ V$                          | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_{O} = 50 \ \mu A; \ V_{CC} = 4.5 \ V$                          | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_{O}$ = 4.0 mA; $V_{CC}$ = 3.0 V                                | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |
|                 |                             | $I_{O}$ = 8.0 mA; $V_{CC}$ = 4.5 V                                | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |
| lı              | input leakage current       | $V_1 = 5.5 V \text{ or GND};$<br>$V_{CC} = 0 V \text{ to } 5.5 V$ | -    | -     | 0.1  | -      | 1.0       | -             | 2.0        | μΑ   |
| I <sub>CC</sub> | supply current              |   | -    | -     | 1.0  | -      | 10        | -             | 40         | μA   |
| Cı              | input<br>capacitance        |   | -    | 1.5   | 10   | -      | 10        | -             | 10         | pF   |
| For type        | 74AHCT1G02                  |   |      |       |      |        |           |               |            |      |
| V <sub>IH</sub> | HIGH-level<br>input voltage | $V_{CC}$ = 4.5 V to 5.5 V   | 2.0  | -     | -    | 2.0    | -         | 2.0           | -          | V    |
| V <sub>IL</sub> | LOW-level input voltage     | $V_{CC}$ = 4.5 V to 5.5 V   | -    | -     | 0.8  | -      | 0.8       | -             | 0.8        | V    |
| V <sub>OH</sub> | HIGH-level                  | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$       |      |       |      |        |           |               |            |      |
| 0.11            | output voltage              | $I_0 = -50 \mu\text{A}$   | 4.4  | 4.5   | -    | 4.4    | -         | 4.4           | -          | V    |
|                 |                             | $I_0 = -8.0 \text{ mA}$   | 3.94 | -     | -    | 3.8    | -         | 3.70          | -          | V    |
| V <sub>OL</sub> | LOW-level                   | $V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$       |      |       |      |        |           |               |            |      |
|                 | output voltage              | $I_0 = 50 \mu\text{A}$  | -    | 0     | 0.1  | -      | 0.1       | -             | 0.1        | V    |
|                 |                             | $I_0 = 8.0 \text{ mA}$  | -    | -     | 0.36 | -      | 0.44      | -             | 0.55       | V    |
| lı              | input leakage<br>current    | $V_I = 5.5 V \text{ or GND};$<br>$V_{CC} = 0 V \text{ to } 5.5 V$ | -    | -     | 0.1  | -      | 1.0       | -             | 2.0        | μΑ   |

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#### Table 7. Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V).

| Symbol Parameter |                           | Conditions   |     | 25 °C |      | −40 °C to +85 °C |     | –40 °C to +125 °C |     | Unit |
|------------------|---------------------------|--|-----|-------|------|------------------|-----|-------------------|-----|------|
|                  |                           |  | Min | Тур   | Max  | Min              | Max | Min               | Max | 1    |
| I <sub>CC</sub>  | supply current            |  | -   | -     | 1.0  | -                | 10  | -                 | 40  | μA   |
| ∆l <sub>CC</sub> | additional supply current | per input pin; V <sub>I</sub> = 3.4 V;<br>other inputs at V <sub>CC</sub> or GND;<br>$I_O = 0 A$ ; V <sub>CC</sub> = 5.5 V | -   | -     | 1.35 | -                | 1.5 | -                 | 1.5 | mA   |
| CI               | input<br>capacitance      |  | -   | 1.5   | 10   | -                | 10  | -                 | 10  | pF   |

### **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

GND = 0 V;  $t_r = t_f = \le 3.0$  ns. For test circuit see <u>Figure 6</u>.

| Symbol          | Parameter                           | Conditions  |            |     | 25 °C |      | <b>−40</b> °C | to +85 °C | –40 °C to +125 °C |      | Unit |
|-----------------|-------------------------------------|---|------------|-----|-------|------|---------------|-----------|-------------------|------|------|
|                 |                                     |   |            | Min | Тур   | Max  | Min           | Max       | Min               | Max  |      |
| For type        | 74AHC1G02                           |   |            |     |       |      |               |           |                   |      |      |
| t <sub>pd</sub> | propagation<br>delay                | A and B to Y;<br>see <u>Figure 5</u>  | <u>[1]</u> |     |       |      |               |           |                   |      |      |
|                 |                                     | $V_{CC}$ = 3.0 V to 3.6 V   | [2]        |     |       |      |               |           |                   |      |      |
|                 |                                     | C <sub>L</sub> = 15 pF  |            | -   | 4.4   | 7.9  | 1.0           | 9.5       | 1.0               | 10.5 | ns   |
|                 |                                     | C <sub>L</sub> = 50 pF  |            | -   | 6.3   | 11.4 | 1.0           | 13        | 1.0               | 14.5 | ns   |
|                 |                                     | $V_{CC}$ = 4.5 V to 5.5 V   | [3]        |     |       |      |               |           |                   |      |      |
|                 |                                     | C <sub>L</sub> = 15 pF  |            | -   | 3.2   | 5.5  | 1.0           | 6.5       | 1.0               | 7.0  | ns   |
|                 |                                     | $C_L = 50 \text{ pF}$   |            | -   | 4.6   | 7.5  | 1.0           | 8.5       | 1.0               | 9.5  | ns   |
| C <sub>PD</sub> | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; \text{ f} = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$ | <u>[4]</u> | -   | 18    | -    | -             | -         | -                 | -    | pF   |
| For type        | 74AHCT1G02                          |   |            |     |       |      |               |           |                   |      |      |
| t <sub>pd</sub> | propagation<br>delay                | A and B to Y;<br>see <u>Figure 5</u>  | [1]        |     |       |      |               |           |                   |      |      |
|                 |                                     | $V_{CC}$ = 4.5 V to 5.5 V   | [3]        |     |       |      |               |           |                   |      |      |
|                 |                                     | C <sub>L</sub> = 15 pF  |            | -   | 3.5   | 5.5  | 1.0           | 6.5       | 1.0               | 7.0  | ns   |
|                 |                                     | $C_L = 50 \text{ pF}$   |            | -   | 4.9   | 7.5  | 1.0           | 8.5       | 1.0               | 9.5  | ns   |
| C <sub>PD</sub> | power<br>dissipation<br>capacitance | per buffer;<br>$C_L = 50 \text{ pF}; f = 1 \text{ MHz};$<br>$V_I = \text{GND to } V_{CC}$         | <u>[4]</u> | -   | 19    | -    | -             | -         | -                 | -    | pF   |

[1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[2] Typical values are measured at V<sub>CC</sub> = 3.3 V.

[3] Typical values are measured at  $V_{CC} = 5.0$  V.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation  $P_D$  ( $\mu$ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

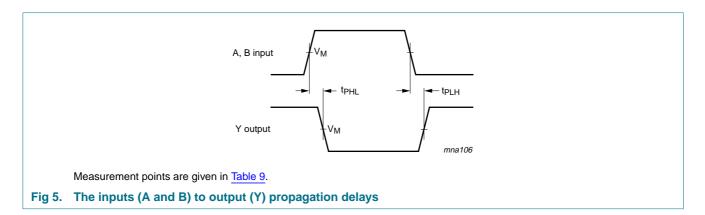
 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in Volts.

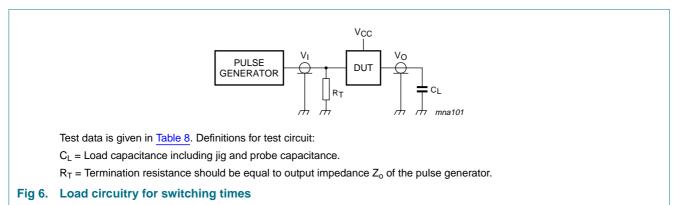
2-input NOR gate

## 12. Waveforms



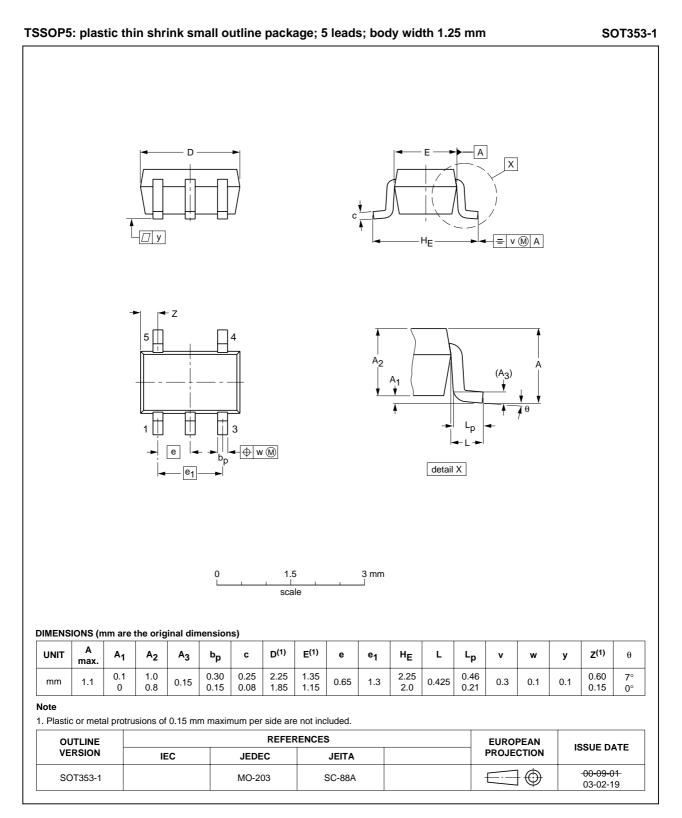
#### Table 9.Measurement point

| Туре       | Input                  |                     | Output              |
|------------|------------------------|---------------------|---------------------|
|            | VI                     | V <sub>M</sub>      | V <sub>M</sub>      |
| 74AHC1G02  | GND to V <sub>CC</sub> | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 74AHCT1G02 | GND to 3.0 V           | 1.5 V               | $0.5 \times V_{CC}$ |



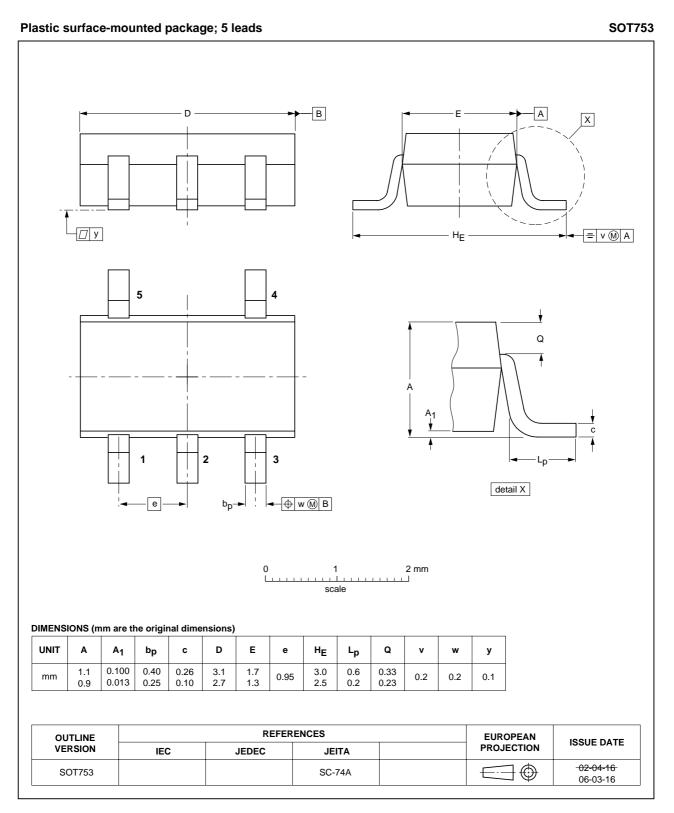
2-input NOR gate

## 13. Package outline



#### Fig 7. Package outline SOT353-1 (TSSOP5)

2-input NOR gate



#### Fig 8. Package outline SOT753 (SC-74A)

2-input NOR gate

## 14. Abbreviations

| Table 10. | Abbreviations               |
|-----------|-----------------------------|
| Acronym   | Description                 |
| CDM       | Charged Device Model        |
| DUT       | Device Under Test           |
| ESD       | ElectroStatic Discharge     |
| HBM       | Human Body Model            |
| MM        | Machine Model               |
| TTL       | Transistor-Transistor Logic |

## 15. Revision history

#### Table 11. Revision history

| Document ID  | Release date                        | Data sheet status              | Change notice         | Supersedes       |  |  |
|--|-------------------------------------|--------------------------------|-----------------------|------------------|--|--|
| 74AHC_AHCT1G02_6   | 20070530                            | Product data sheet             | -                     | 74AHC_AHCT1G02_5 |  |  |
| Modifications:  • The format of this data sheet has been redesigned to comply with the new ide guidelines of NXP Semiconductors. |                                     |                                |                       |                  |  |  |
|  | <ul> <li>Legal texts h</li> </ul>   | ave been adapted to the new o  | company name wher     | e appropriate.   |  |  |
|  | <ul> <li>Package SO</li> </ul>      | T353 changed to SOT353-1 in    | Section 3 and Section | <u>on 13</u> .   |  |  |
|  | <ul> <li>Quick reference</li> </ul> | nce data and Soldering section | is removed.           |                  |  |  |
| 74AHC_AHCT1G02_5   | 20020527                            | Product specification          | -                     | 74AHC_AHCT1G02_4 |  |  |
| 74AHC_AHCT1G02_4   | 20020215                            | Product specification          | -                     | 74AHC_AHCT1G02_3 |  |  |
| 74AHC_AHCT1G02_3   | 20010131                            | Product specification          | -                     | 74AHC_AHCT1G02_2 |  |  |
| 74AHC_AHCT1G02_2   | 19990127                            | Product specification          | -                     | 74AHC_AHCT1G02_1 |  |  |
| 74AHC_AHCT1G02_N_1   | 19981125                            | Preliminary specification      | -                     | -                |  |  |
|  |                                     |                                |                       |                  |  |  |

## **16. Legal information**

#### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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#### **NXP Semiconductors**

# 74AHC1G02; 74AHCT1G02

2-input NOR gate

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